

DATASHEET

6 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER CNY17-X Series CNY17F-X Series







Features:

• Current transfer ratios in selected narrow range groups

CNY17-1, CNY17F-1: 40-80%

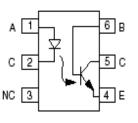
CNY17-2, CNY17F-2: 63-125%

CNY17-3, CNY17F-3: 100-200%

CNY17-4, CNY17F-4:160-320%

- High isolation voltage between input and output (Viso = 5000 Vrms)
- Creepage distance > 7.6 mm
- Operating temperature up to +110°C
- The CNY17F-X series offers no external base connection for minimum noise susceptibility
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved

Schematic

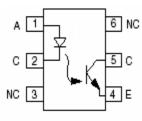


<u>CNY17-X</u>

Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. Emitter
- 5. Collector
- 6. Base

Schematic



CNY17F-X

Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. Emitter
- 5. Collector
- 6. No Connection

Description

The CNY17-X and CNY17F-X series of devices each consist of an infrared emitting diode optically coupled to a phototransistor.

They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs



Absolute Maximum Ratings (Ta=25℃)

	Parameter	Symbol	Rating	Unit
	Forward current	I _F	60	mA
	Peak forward current (t = 10µs)	I _{FM}	1	А
Input	Reverse voltage	V _R	6	V
	Power dissipation ($T_A = 25$ °C)	р	100	mW
	Derating factor (above 100°C)	P _D —	3.8	mW/°C
	Collector-Emitter voltage	V_{CEO}	80	V
	Collector-Base voltage*1	V_{CBO}	80	V
Output	Emitter-Collector voltage	V _{ECO}	7	V
	Emitter-Base voltage	V _{EBO}	7	V
	Power dissipation (T _A = 25°C)	D	150	mW
	Derating factor (above 100°C)	P _C —	9.0	mW/°C
Total Power Dissipation		P _{TOT}	200	mW
Isolation voltage *2		V_{ISO}	5000	V rms
Operating Temperature		T _{OPR}	-55 to 110	°C
Storage Temperature		T _{STG}	-55 to 125	°C
Soldering temperature *3		T _{SOL}	260	°C

Notes:

^{*1} Only for CNY17-X series.

^{*2} AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

^{*3} For 10 seconds.



Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	V_{F}	-	-	1.65	V	$I_F = 60 \text{mA}$
Reverse current	I_{R}	-	-	10	μΑ	$V_R = 6V$
Input capacitance	C _{in}	-	18	-	pF	V = 0, f = 1MHz

Output

Parameter		Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Base dark current	CNY17-X only	I _{CBO}	-	-	20	nA	V _{CB} = 10V, I _F = 0mA
Collector-Emitter dark current		I_{CBO}		-	50	nA	V _{CE} = 10V, IF=0mA
Collector-Emitter breakdown voltage		BV_CEO	80	-	-	V	$I_C = 1 \text{mA}, I_F = 0 \text{mA}$
Collector-Base breakdown voltage	CNY17-X only	BV _{CBO}	80	-	-	V	$I_C = 0.1 \text{mA},$ $I_F = 0 \text{mA}$
Emitter-Collector breakdown voltage		BV _{ECO}	7	-	-	V	$I_E = 0.1 \text{mA},$ $I_F = 0 \text{mA}$
Collector-Emitter capacitance		C_CE	-	8	-	pF	VCE = 0V, f = 1MHz

^{*} Typical values at $T_a = 25$ °C



Transfer Characteristics

Parameter		Symbol	Min	Тур.	Max.	Unit	Condition	
Current Transfer Ratio	CNY17-1 CNY17F-1		40	-	80	- %		
	CNY17-2 CNY17F-2		63	-	125		$I_F = 10$ mA $V_{CE} = 5$ V	
	CNY17-3 CNY17F-3	– CTR -	100	-	200			
	CNY17-4 CNY17F-4		160	-	320			
	CNY17-1 CNY17F-1		13	-	-	· %		
Current	CNY17-2 CNY17F-2	- CTD	22	-	-		$I_F = 1 \text{mA}$, $V_{CE} = 5 \text{V}$	
Transfer Ratio	CNY17-3 CNY17F-3	- CTR - 	34	-	-			
	CNY17-4 CNY17F-4		56	-	-			
Collector-Emitter saturation voltage		V _{CE(sat)}	-	-	0.3	V	I _F = 10mA , I _C = 2.5mA	
Isolation resistance		R _{IO}	10 ¹¹	-	-	Ω	V _{IO} = 500Vdc	
Input-outpu	Input-output capacitance		-	0.5	-	pF	$V_{IO} = 0$, $f = 1MHz$	
Turn-on tim	ne	T_{on}	-	10	12			
Turn-off time		T_{off}	-	9	12		$V_{CC} = 10V$,	
Rise time		T_r	-	6	10	μs	I_C = 2mA, R_L = 100 Ω See Fig. 11	
Fall time		T_f	-	8	10			
Rise time		T_r	-	2	10		$V_{CC} = 5V, I_F = 10mA,$	
Fall time		T_f	-	3	10		$R_L = 75\Omega$, See Fig. 11	

^{*} Typical values at T_a = 25°C



Typical Electro-Optical Characteristics Curves

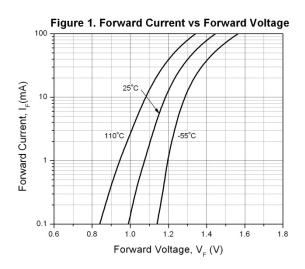


Figure 2. Current Tranfer Ratio vs Forward Current

1.2

0.6

0.7

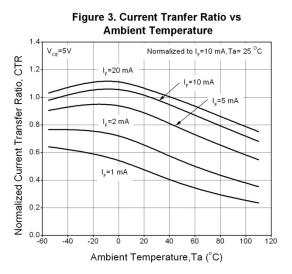
0.4

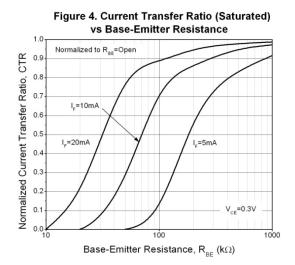
V_{ce}=5 V

Ta=25°C

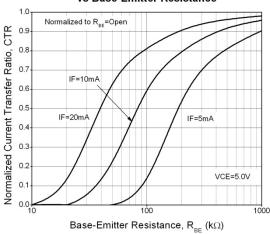
Normalized to I_p=10 mA

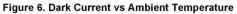
Forward Current, I_E (mA)

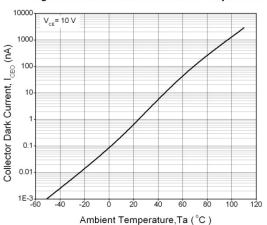












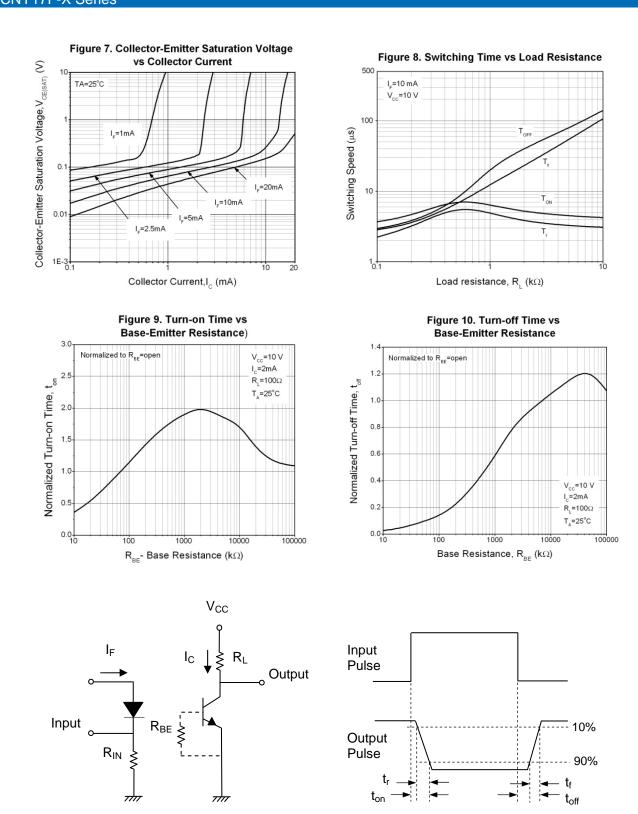


Figure 11. Switching Time Test Circuit & Waveforms



Order Information

Part Number

CNY17-XY(Z)-V or CNY17F-XY(Z)-V

Note

Χ = Part no. (1, 2, 3 or 4)

Υ = Lead form option (S, S1, M or none)

Z V = Tape and reel option (TA, TB or none).

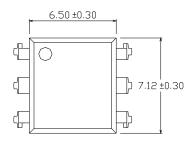
= VDE (optional)

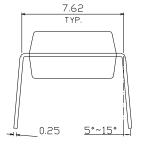
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

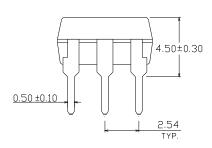


Package Dimension (Dimensions in mm)

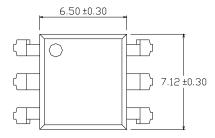
Standard DIP Type

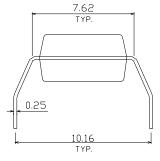


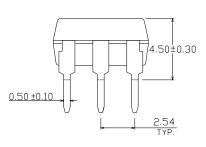




Option M Type

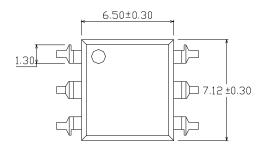


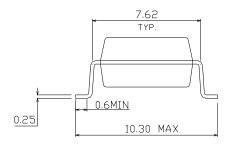


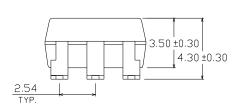




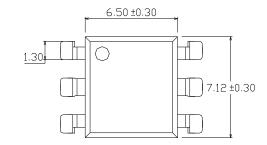
Option S Type

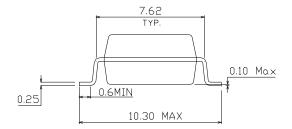


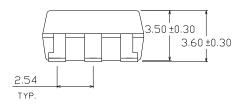




Option S1 Type

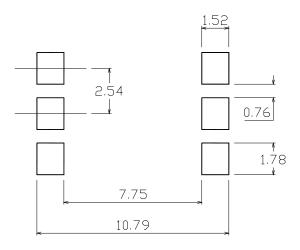




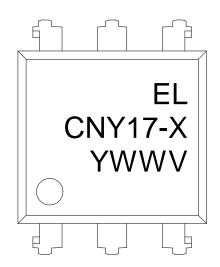




Recommended pad layout for surface mount leadform



Device Marking



Notes

EL denotes Everlight

CNY17-X denotes Device Number (X: 1, 2, 3 or 4)

Y denotes 1 digit Year code WW denotes 2 digit Week code V denotes VDE (optional) Direction of feed from reel

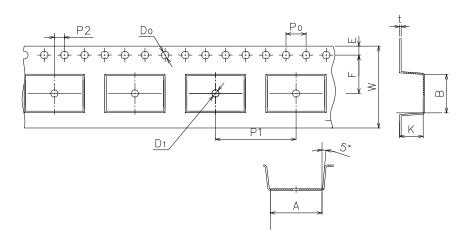


Direction of feed from reel

Tape & Reel Packing Specifications

Option TA Option TB Option TB

Tape dimensions



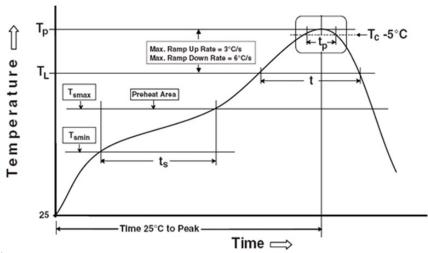
Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.52±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm)	4.0±0.15	16.0±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin}) 150 °C Temperature max (T_{smax}) 200°C

60-120 seconds Time $(T_{smin} \text{ to } T_{smax}) (t_s)$ Average ramp-up rate $(T_{smax} \text{ to } T_p)$ 3 °C/second max

Other

Liquidus Temperature (T_L) Time above Liquidus Temperature (t L) 60-100 sec

Peak Temperature (T_P)

Time within 5 °C of Actual Peak Temperature: T_P - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

217 °C

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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